

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TETSUYA KATANO	07/25/2019
MASAYUKI AIZAWA	07/25/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TYCO ELECTRONICS JAPAN G.K.
<b>Street Address:</b>	5-8, HISAMOTO 3-CHOME, TAKATSU-KU
<b>City:</b>	KAWASAKI-SHI
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	213-8535
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16522760
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(302)633-2776
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	302-633-2740
<b>Email:</b>	ipdocket.wilm@te.com
<b>Correspondent Name:</b>	THE WHITAKER LLC
<b>Address Line 1:</b>	4550 LINDEN HILL ROAD
<b>Address Line 2:</b>	SUITE 140
<b>Address Line 4:</b>	WILMINGTON, DELAWARE 19808
<b>ATTORNEY DOCKET NUMBER:</b>	TE-01542 (958-7026)
<b>NAME OF SUBMITTER:</b>	JAY J. HOETTE
<b>SIGNATURE:</b>	/Jay J. Hoette/
<b>DATE SIGNED:</b>	07/26/2019
<b>Total Attachments: 1</b>	
source=TE-01542_JP-DeclarationandAssignment_26JULY2019#page1.tif	

**COMBINED DECLARATION AND ASSIGNMENT**

As a below named and signing inventor, I hereby declare that:  
this declaration is directed to inventions and improvements disclosed in:

☒ the attached application, or  
☐ United States application or PCT international application number \_\_\_\_\_ filed on \_\_\_\_\_,  
entitled CONTACT MODULE FOR A CONNECTOR ASSEMBLY ("the APPLICATION");

the APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56; and

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TYCO ELECTRONICS JAPAN G.K. ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of Japan, having its principal place of business at 5-8, Hisamoto 3-Chome, Takatsu-ku, Kawasaki-shi, Kanagawa 213-8535, Japan

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries, including all priority rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Tetsuya Katano	<i>T. Katano</i>	7/25/2019
Masayuki Aizawa	<i>M. Aizawa</i>	7/25/2019